505948685 03/04/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHIEN-WEN CHEN	02/27/2020

RECEIVING PARTY DATA

Name:	REALTEK SEMICONDUCTOR CORP.	
Street Address:	NO.2, INNOVATION ROAD II, HSINCHU SCIENCE PARK,	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16808579

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	108P000166US	
NAME OF SUBMITTER:	ZHUO XU	
SIGNATURE:	/ZHUO XU/	
DATE SIGNED:	03/04/2020	

Total Attachments: 2

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PATENT 505948685 REEL: 052007 FRAME: 0996

ASSIGNMENT DEED

Attorney docket No. 108P000166US

This Assignment agreement is applicable to an invention entitled (invention Title):

DELAY CIRCUIT
The PATENT RIGHTS referred to in this agreement are:
(Check one)
 a Patent Application for this invention, executed by the ASSIGNOR(S) concurrently with this Assignment U.S. Patent Application Serial No.
U.S. Patent Application Serial No, filed, filed
The PATENT RIGHTS assigned under this agreement are:
(Check One)
U.S. Patent rights only
☐ worldwide Patent rights. In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. Patent Application identified above.
I/WE believe that I/WE am/are the original inventor(s) of a claimed invention in the application.
The above-identified Application was made or authorized by me/us.
I/WE hereby acknowledge that any will false statements made in this Assignment is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.
The ASSIGNOR(S) referred to in this agreement is (or are):
(Full name of sole or first assignor) CHIEN-WEN CHEN (FAMILY NAME:CHEN)
(Address) NO. 6, ALY. 5, LN. 1200, MINGHU RD., EAST DIST., HSINCHU CITY 300, TAIWAN,
R.O.C.
(Full name of second joint assignor, if any)
(Address)
(Full name of third joint assignor, if any)
(Address)
☐ Additional assignors are being named on separately numbered sheets attached hereto.
The sole or first ASSIGNEE(S) referred to in this agreement is (or are):
(Name of Assignee) REALTEK SEMICONDUCTOR CORP.
(Address of Assignee) NO.2, INNOVATION ROAD II, HSINCHU SCIENCE PARK, HSINCHU 300,
TAIWAN, R.O.C.
The sole or first ASSIGNEE is: (Check One)
☐an individual
☐ a partnership
■ a Corporation of TAIWAN ,R.O.C. (State or Country)

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The second ASSIGNEE(S) (if any) referre	ed to in this agreement is (or are):
(Name of Assignee)	
(Address of Assignee)	
The second ASSIGNEE is: (Check One)	
☐an individual	
☐ a partnership	
a Corporation of	((State or Country)
☐ Additional assignees are being name	d on separately numbered sheets attached hereto
	1.00 paid by each ASSIGNEE, and other good and valuable we and do hereby assign the following to each ASSIGNEE; their
the full and exclusive right to the invention	n;
	, title and interest in and to the PATENT RIGHTS in the visionals, re-issues, and re-examination patents and
the right to claim priority under 35 U.S.C.	§ 119, based on any earlier foreign applications for this invention.
request(s) the Commissioner of Patents and Trader	ed under this Agreement, the ASSIGNOR(S) hereby authorize(s) and marks to issue all Letters Patent to the ASSIGNEE(S) as the t, title and interest, for the sole use and enjoyment of said
known to the ASSIGNOR(S) respecting said inventi all divisional, continuation, substitute, renewal, reex papers to cause any and all Letters Patent to be iss	ommunicate to said ASSIGNEE(S), or their representatives, any facts on, and testify in any legal proceedings, sign all lawful papers, execute amination and reissue applications, execute all necessary assignment ued to said ASSIGNEE(S), make all rightful oaths and generally do GNEE(S), their successors and assigns, to obtain and enforced proper
Application when known.	rt the Serial Number and filing date of the above-referenced Patent CHEN (FAMILY NAME:CHEN)
CHIEN - WEN CHEN (Signature of sole or first assignor)	
(Signature of second assignor, if any)	(Date)
(Signature of third assignor, if any)	(Date)

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